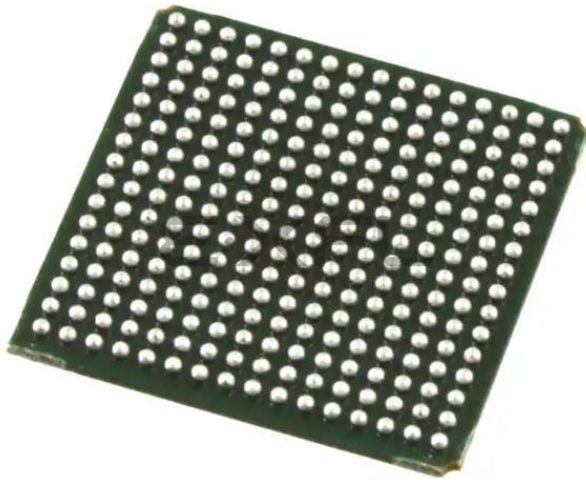




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	2704
Total RAM Bits	113664
Number of I/O	160
Number of Gates	210000
Voltage - Supply	2.3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfx200eb-05fn256c



Product Line	Ordering Part Number	Product Status	Reference PCN
LFX500B	LFX500B-03F516C	Discontinued	PCN#09-10
	LFX500B-04F516C		
	LFX500B-05F516C		
	LFX500B-03F900C		
	LFX500B-03FN900C		
	LFX500B-04F900C		
	LFX500B-04FN900C		
	LFX500B-05F900C		
	LFX500B-05FN900C		
LFX500C	LFX500C-03F516C	Discontinued	PCN#09-10
	LFX500C-04F516C		
	LFX500C-03F900C		
	LFX500C-03FN900C		
	LFX500C-04F900C		
	LFX500C-04FN900C		
LFX1200B	LFX1200B-03FE680C	Discontinued	PCN#03A-10
	LFX1200B-04FE680C		
	LFX1200B-05FE680C		
	LFX1200B-03F900C		
	LFX1200B-04F900C		
	LFX1200B-05F900C		
LFX1200C	LFX1200C-03FE680C	Discontinued	PCN#03A-10
	LFX1200C-04FE680C		
	LFX1200C-03F900C		
	LFX1200C-04F900C		
LFX125EB	LFX125EB-03F256C	Active / Orderable	
	LFX125EB-03FN256C		
	LFX125EB-04F256C		
	LFX125EB-04FN256C		
	LFX125EB-05F256C		
	LFX125EB-05FN256C		
	LFX125EB-03F256I		
	LFX125EB-03FN256I		
	LFX125EB-04F256I		
	LFX125EB-04FN256I		
	LFX125EB-03F516C	Discontinued	PCN#09-10
	LFX125EB-04F516C		
	LFX125EB-05F516C		
	LFX125EB-03F516I		
	LFX125EB-04F516I		
	LFX125EB-03F256C	Discontinued	PCN#09-10
	LFX125EB-03FN256C		
	LFX125EB-04F256C		
	LFX125EB-04FN256C		
	LFX125EB-03F256I		
	LFX125EB-03FN256I		
LFX125EC	LFX125EC-03F256C	Discontinued	PCN#09-10
	LFX125EC-03FN256C		
	LFX125EC-04F256C		
	LFX125EC-04FN256C		
	LFX125EC-03F256I		
	LFX125EC-03FN256I		

Configurable Logic Element

The CLE is made up of a four-input Look-up Table (LUT-4), a Carry Chain Generator (CCG), and a two-input AND gate. The LUT-4 creates various combinatorial and memory elements, the CCG creates a single one-bit full adder, and the two-input AND gate can expand the CCG to incorporate Booth Multiplier capability by feeding the output of the AND gate to one of the inputs of the CCG.

Of the five inputs that feed each CLE, two are dedicated inputs into each LUT-4 and the remaining three take on varying functionality. The third and fourth inputs can be used as either inputs to the LUT-4 or as a Feed-Thru to the CSE via the WLG. The fifth input can be a data port when the LUT is configured as Distributed Memory, a select line for multiplexer operation, or a Feed-Thru directly to the CSE via the WLG (Figure 2).

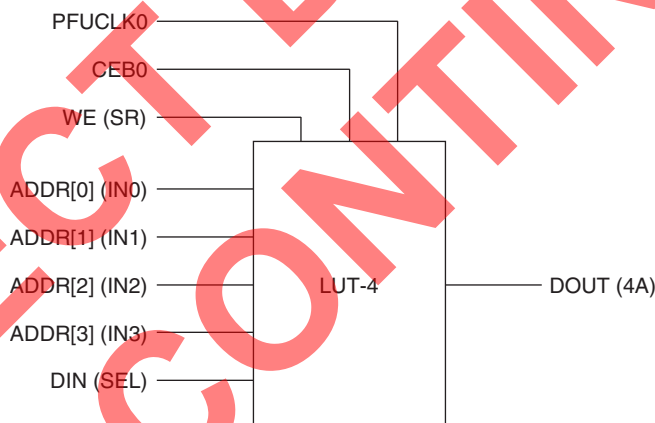
Look-Up Table – Combinatorial Mode

In combinatorial mode, the LUT-4 can implement any logic function up to four inputs. By using the carry chain and the WLG, each LUT-4 can be combined to form the enhanced functions listed in Table 3.

Look-Up Table – Distributed Memory Mode

In the distributed memory mode, the LUT functions as a memory element. The inputs to the LUT function as Address and Data. Each PFU is capable of implementing up to 64 SRAM bits. Both single and double port RAM can be performed in the PFU (Table 3). Furthermore, the distributed memory can be configured as either synchronous or asynchronous memory. Figure 3 illustrates the LUT while in distributed memory mode. When using any LUT in the PFU in memory mode, the Set/Reset signal will be used for Write Enable (WE(SR)) and the CLK0 signal will be used as the clock for synchronous read and write.

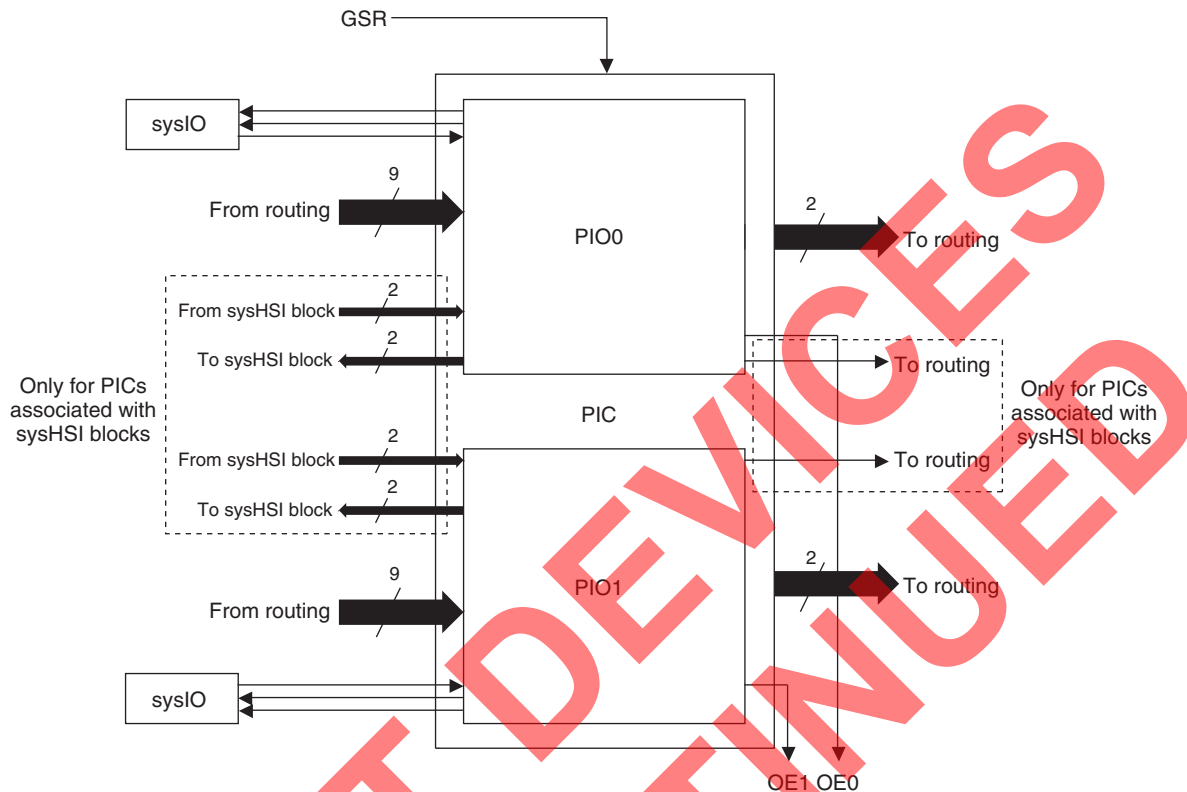
Figure 3. LUT in Distributed Memory Mode



Look-Up Table – Shift Register Mode

In the shift register mode, the LUT functions as a 1-bit to 8-bit shift register. This means that each PFU can implement up to four 8-bit shift registers or any cascaded combination. Figure 4 illustrates the LUT when configured in shift register mode.

Figure 10. ispXPGA PIC

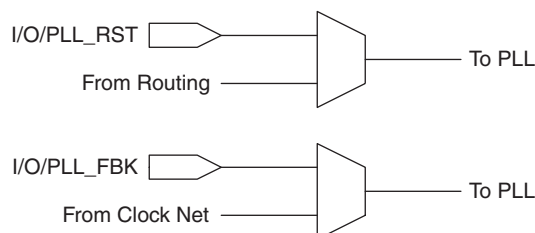


Programmable Input/Output

The PIO is the building block of a PIC. The PIO has a total of 11 inputs and five outputs. Nine of the 11 inputs are generated from routing. The inputs from routing are the PIO Input (IN), Feed-Thru (FT), Clock (CLK), Input Clock Enable (ICE), Input Set/Reset (ISR), Output Clock Enable (OCEN), Output Set/Reset (OSR), PIO Output Enable (OEN), and PIO Input Enable (IEN). The remaining inputs are the sysIO input buffer signal and the Global Set/Reset signal. Three of the five outputs (OUT0, OUT1, and OE) feed routing. The last two outputs feed the sysIO buffer directly as the output and output enable of the sysIO output buffer.

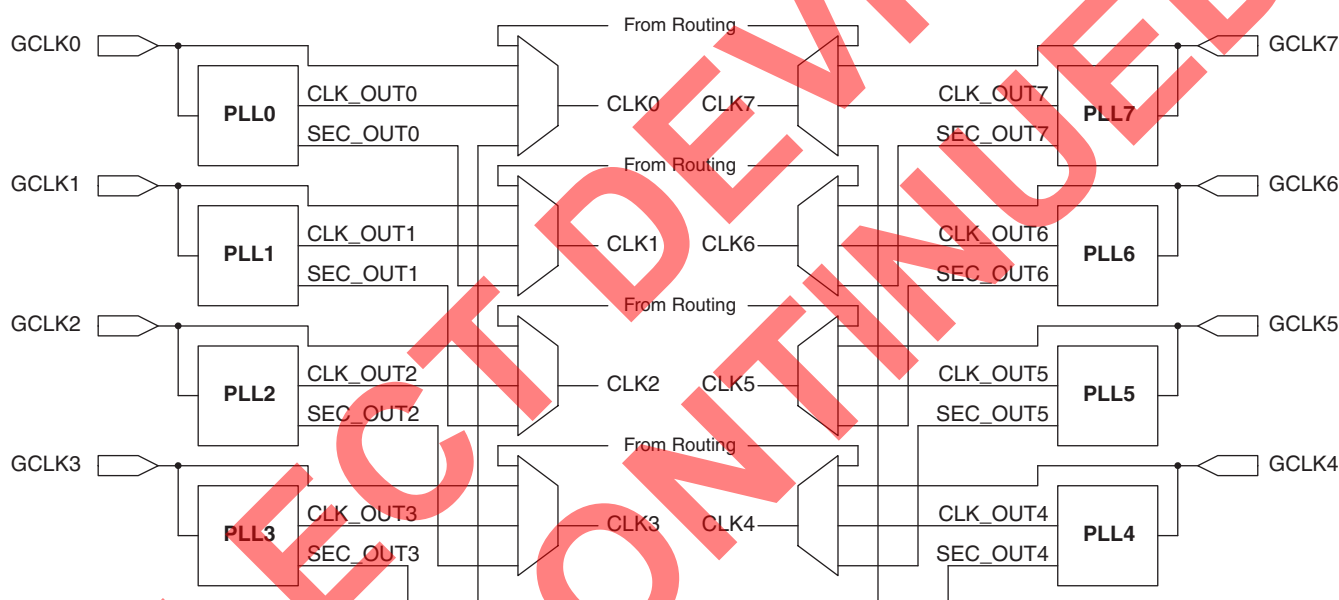
PIOs associated with sysHSL blocks contain two additional inputs and outputs to support the sysHSL block. The two inputs come from the sysHSL block associated with the PIO, and the two outputs feed the sysHSL block. One of the inputs routes directly through the PIO to routing, while the other is multiplexed with the Feed-Thru, register bypass, and Q output of the register to form the OUT1 output of the PIO. The outputs to the sysHSL block are the same signals as the outputs which feed the sysIO buffers (sysIO Output and sysIO Output Enable).

Each PIO has an input register, an output register, and an output enable register as shown in Figure 11. The input register path of the PIO has a 'delay' option, which slows the data-flow. A two-input OR function of the Global Set/Reset (GSR) and Set/Reset (ISR or OSR) signals creates the set/reset term for the respective registers. Each PIO has two pairs of set/reset and clock enable signals. One is exclusive to the input register, whereas the other is common for both the output and output enable registers. The clock (CLK) is common to all registers in a PIO, and the polarity of the clock is controllable. The input, output, and the output enable registers can be configured as a latch or D-type flip-flop. Each PIO is capable of generating an output enable signal, which in turn becomes a PIC output.

Figure 17. ispXPGA PLL_RST and PLL_FBK Generation

Clock Routing

The Global Clock Lines (GCLK) have two sources, their dedicated pins and the sysCLOCK circuit. Figure 18 illustrates the generation of the Global Clock Lines.

Figure 18. Global Clock Line Generation

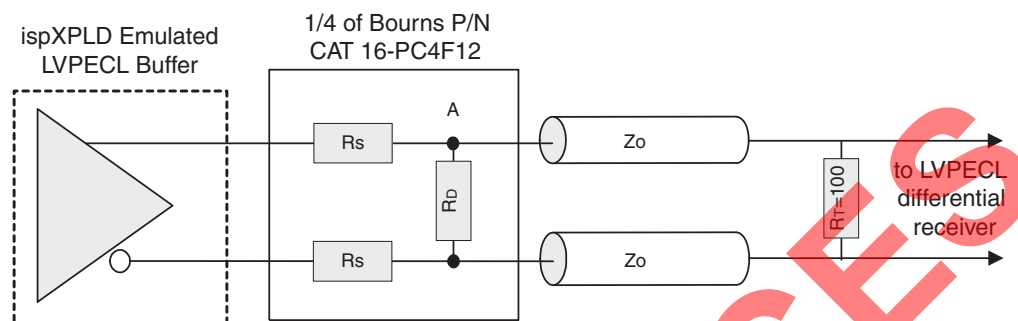
sysIO Capability

All the ispXPGA devices have eight sysIO banks, where each bank is capable of supporting multiple I/O standards. Each sysIO bank has its own I/O supply voltage (V_{CCO}) and reference voltage (V_{REF}) resources allowing each bank complete independence from the others. Each I/O is individually configurable based on the bank's V_{CCO} and V_{REF} settings. In addition, each I/O has configurable drive strength, weak pull-up, weak pull-down, or a bus-keeper latch. Table 4 lists the number of I/Os supported per bank in each of the ispXPGA devices. In addition, 5V tolerant inputs are specified within an I/O bank that is connected to V_{CCO} of 3.0V to 3.6V for LVCMOS 3.3, LVTTTL and PCI interfaces.

Table 5 lists the sysIO standards with the typical values for V_{CCO} , V_{REF} and V_{TT} .

The TOE, JTAG TAP pins, PROGRAM, CFG0 and DONE pins of the ispXPGA device are the only pins that do not have the sysIO capabilities. The TOE and CFG0 pins operate off the V_{CC} of the device, supporting only the LVCMOS standard corresponding to the device supply voltage. The TAP pins have a separate supply voltage (V_{CCJ}), which determines the LVCMOS standard corresponding to that supply voltage.

There are three classes of I/O interface standards that are implemented in the ispXPGA devices. The first is the un-terminated, single-ended interface. It includes the 3.3V LVTTTL standard along with the 1.8V, 2.5V, and 3.3V LVCMOS interface standards. Additionally, PCI and AGP-1X are subsets of this type of interface.

Figure 23. LVPECL Driver with Three Resistor Pack

ispXPGA 125B/C & ispXPGA 125EB/EC External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description	Conditions	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{CO}	Global Clock Input to Output	PIO Output Register	—	5.3	—	5.7	—	6.6	ns
t_S	Global Clock Input Setup	PIO Input Register without input delay	-1.9	—	-1.8	—	-1.5	—	ns
t_H	Global Clock Input Hold	PIO Input Register without input delay	2.7	—	2.9	—	3.3	—	ns
t_{SINDLY}	Global Clock Input Setup	PIO Input Register with input delay	3.1	—	3.3	—	3.8	—	ns
t_{HINDLY}	Global Clock Input Hold	PIO Input Register with input delay	0.0	—	0.0	—	0.0	—	ns
t_{COPLL}	Global Clock Input to Output	PIO Output Register using PLL without delay	—	3.6	—	3.9	—	4.5	ns
t_{SPLL}	Global Clock Input Setup	PIO Input Register without input delay using PLL without delay	0	—	0.1	—	0.3	—	ns
t_{HPLL}	Global Clock Input Hold	PIO Input Register without input delay using PLL without delay	0.9	—	1.0	—	1.2	—	ns
$t_{SINDLYPLL}$	Global Clock Input Setup	PIO Input Register with input delay using PLL without delay	5.1	—	5.5	—	6.3	—	ns
$t_{HINDLYPLL}$	Global Clock Input Hold	PIO Input Register with input delay using PLL without delay	-3.0	—	-2.8	—	-2.4	—	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 200B/C & ispXPGA 200EB/EC External Switching Characteristics**Over Recommended Operating Conditions**

Parameter	Description	Conditions	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{CO}	Global Clock Input to Output	PIO Output Register	—	5.5	—	5.9	—	6.8	ns
t_S	Global Clock Input Setup	PIO Input Register without input delay	-2.0	—	-2.0	—	-1.7	—	ns
t_H	Global Clock Input Hold	PIO Input Register without input delay	3.7	—	3.8	—	4.4	—	ns
t_{SINDLY}	Global Clock Input Setup	PIO Input Register with input delay	3.8	—	3.8	—	4.4	—	ns
t_{HINDLY}	Global Clock Input Hold	PIO Input Register with input delay	0.0	—	0.0	—	0.0	—	
t_{COPLL}	Global Clock Input to Output	PIO Output Register using PLL without delay	—	3.3	—	3.6	—	4.2	ns
t_{SPLL}	Global Clock Input Setup	PIO Input Register without input delay using PLL without delay	-0.2	—	-0.2	—	0.1	—	ns
t_{HPLL}	Global Clock Input Hold	PIO Input Register without input delay using PLL without delay	1.5	—	1.5	—	1.8	—	ns
$t_{SINDLYPLL}$	Global Clock Input Setup	PIO Input Register with input delay using PLL without delay	6.3	—	6.3	—	7.3	—	ns
$t_{HINDLYPLL}$	Global Clock Input Hold	PIO Input Register with input delay using PLL without delay	-2.7	—	-2.6	—	-2.2	—	ns

1. Only available for ispXPGA 200B and ispXPGA 200EB (2.5V/3.3V) devices.

Timing v.0.2

ispXPGA 500B/C & ispXPGA 500EB/EC External Switching Characteristics**Over Recommended Operating Conditions**

Parameter	Description	Conditions	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{CO}	Global Clock Input to Output	PIO Output Register	—	6.4	—	6.9	—	7.9	ns
t_S	Global Clock Input Setup	PIO Input Register without input delay	-2.9	—	-2.7	—	-2.3	—	ns
t_H	Global Clock Input Hold	PIO Input Register without input delay	3.6	—	3.9	—	4.5	—	ns
t_{SINDLY}	Global Clock Input Setup	PIO Input Register with input delay	3.3	—	3.6	—	4.1	—	ns
t_{HINDLY}	Global Clock Input Hold	PIO Input Register with input delay	0.0	—	0.0	—	0.0	—	ns
t_{COPLL}	Global Clock Input to Output	PIO Output Register using PLL without delay	—	3.2	—	3.4	—	3.9	ns
t_{SPLL}	Global Clock Input Setup	PIO Input Register without input delay using PLL without delay	0.1	—	0.2	—	0.3	—	ns
t_{HPLL}	Global Clock Input Hold	PIO Input Register without input delay using PLL without delay	0.8	—	0.9	—	1.0	—	ns
$t_{SINDLYPLL}$	Global Clock Input Setup	PIO Input Register with input delay using PLL without delay	6.7	—	7.2	—	8.3	—	ns
$t_{HINDLYPLL}$	Global Clock Input Hold	PIO Input Register with input delay using PLL without delay	-4.3	—	-4.0	—	-3.4	—	ns

1. Only available for ispXPGA 500B and ispXPGA 500EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 500B/C & ispXPGA 500EB/EC Timing Adders

Parameter	Description	Base Parameter	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
t _{IOINDLY}	Input Delay	—	—	5.21	—	5.60	—	6.44	ns
t _{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_18_in	Using 1.8V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVC MOS_25_in	Using 2.5V CMOS	t _{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVC MOS_33_in	Using 3.3V CMOS	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
t _{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVC MOS Outputs only)	t _{IOBUF} , t _{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVC MOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVC MOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVC MOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVC MOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVC MOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVC MOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns

ispXPGA 500B/C & ispXPGA 500EB/EC Timing Adders (Cont.)

Parameter	Description	Base Parameter	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
LVC MOS_33_4mA_out	Using 3.3V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVC MOS_33_5.33mA_out	Using 3.3V CMOS Standard, 5.33mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVC MOS_33_8mA_out	Using 3.3V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVC MOS_33_12mA_out	Using 3.3V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_33_16mA_out	Using 3.3V CMOS Standard, 16mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_33_24mA_out	Using 3.3V CMOS Standard, 24mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_out	Using AGP 1x Standard	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
CTT25_out	Using CTT 2.5V	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
CTT33_out	Using CTT 3.3V	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
GTL+_out	Using GTL+	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_out	Using HSTL 2.5V, Class I	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
BLVDS_out	Using Bus Low Voltage Differential Signaling (BLVDS)	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVPECL_out	Using Low Voltage PECL	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
PCI_out	Using PCI Standard	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns

1. Only available for ispXPGA 500B and ispXPGA 500EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 1200B/C & ispXPGA 1200EB/EC Timing Adders

Parameter	Description	Base Parameter	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
t _{IOINDLY}	Input Delay	—	—	5.58	—	6.0	—	6.90	ns
t _{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_18_in	Using 1.8V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVC MOS_25_in	Using 2.5V CMOS	t _{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVC MOS_33_in	Using 3.3V CMOS	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
t _{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVC MOS Outputs only)	t _{IOBUF} , t _{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVC MOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVC MOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVC MOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVC MOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVC MOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVC MOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns

REFCLK and SS_CLKIN Timing

Symbol	Description	Mode	Condition	Min	Max	Unit
$t_{DREFCLK}$	Frequency Deviation Between TX REFCLK and CDRX REFCLK on One Link	8B10B/ 10B12B		-100	100	ppm
$t_{JPPREFCLK}$	REFCLK, SS_CLKIN Peak-to-Peak Period Jitter	All	Random Jitter		0.01	UIPP
$t_{PWREFCLK}$	REFCLK, SS_CLKIN Pulse Width, (80% to 80% or 20% to 20%).	All	40-100MHz	2		ns
			100-200MHz	1		
$t_{RREFCLK}$	REFCLK, SS_CLKIN Rise/Fall Time (20% to 80% or 80% to 20%)	All			2	ns

Serializer Timing²

Symbol	Description	Mode	Condition	Min	Max	Unit
t_{JPSOUT}	SOUT Peak-to-Peak Output Data Jitter	All	f_{CLK} with no jitter		0.25	UIPP
$t_{JPP8B10B}$	SOUT Peak-to-Peak Random Jitter	8B10B	800 Mbps w/K28.7-		130	ps
	SOUT Peak-to-Peak Deterministic Jitter	8B10B	800 Mbps w/K28.5+		160	ps
t_{RFSOUT}	SOUT Output Data Rise/Fall Time (20%, 80%)	LVDS			700	ps
t_{COSOUT}	REFCLK to SOUT Delay	SS/8B10B		$2Bt^1 + 2$	$2Bt^1 + 10$	ns
		10B12B		$1Bt^1 + 2$	$1Bt^1 + 10$	ns
t_{SKTX}	Skew of SOUT with Respect to SS_CLKOUT	SS			300	ps
$t_{CKOSOUT}$	SS_CLKOUT to bit0 of SOUT	SS		$2Bt^1 - t_{SKTX}$	$2Bt^1 + t_{SKTX}$	ns
$t_{HSITXDDATAS}$	TXD Data Setup Time	All	Note 3	1.5		ns
$t_{HSITXDDATAH}$	TXD Data Hold Time	All	Note 3		1.0	ns

1. Bt: Bit Time Period. High Speed Serial Bit Time.

2. The SIN and SOUT jitter specifications listed above are under the condition that the clock tree that drives the REFCLK to sysHSI Block is in sysCLOCK PLL BYPASS mode.

3. Internal timing for reference only.

Deserializer Timing

Symbol	Description	Mode	Conditions	Min	Max	Units
f_{DSIN}	SIN Frequency Deviation from REFCLK	8B10B/ 10B12B		-100	100	ppm
e_{OSIN}	SIN Eye Opening Tolerance	All	Notes 1, 2	0.45		UIPP
ber	Bit Error Rate	All			10^{-12}	Bits
$t_{HSIOUTVALIDPRE}$	RXD, SYDT Valid Time Before RECCLK Falling Edge	All	Note 3	$t_{RCP}/2 - 0.7$		ns
$t_{HSIOUTVALIDPOST}$	RXD, SYDT Valid Time After RECCLK Falling Edge	All	Note 3	$t_{RCP}/2 - 0.7$		ns
t_{DSIN}	Bit 0 of SIN Delay to RXD Valid at RECCLK Falling edge	All		$1.5 t_{RCP} + 4.5Bt + 3$	$1.5 t_{RCP} + 4.5Bt + 15$	ns

1. Eye opening based on jitter frequency of 100KHz.

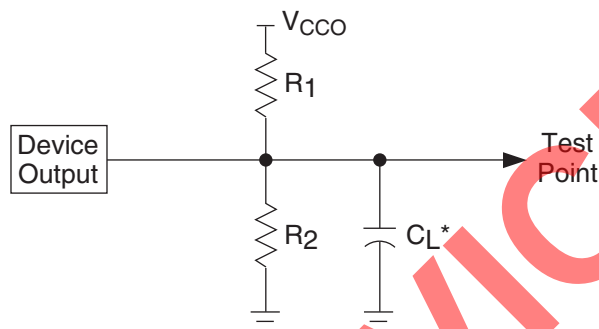
2. Lower frequency operation assumes maximum eye closure of 800ps.

3. Internal timing for reference only.

Switching Test Conditions

Figure 25 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 7.

Figure 25. Output Test Load, LVTTTL and LVC MOS Standards



* C_L includes test fixture and probe capacitance.

Table 7. Text Fixture Required Components

Test Condition	R_1	R_2	C_L	Timing Reference	VCCO
LVC MOS I/O, (L → H, H → L)	106	106	35pF	LVC MOS 3.3 = $V_{CCO}/2$	LVC MOS 3.3 = 3.0V
				LVC MOS 2.5 = $V_{CCO}/2$	LVC MOS 2.5 = 2.3V
				LVC MOS 1.8 = $V_{CCO}/2$	LVC MOS 1.8 = 1.65V
Default LVC MOS 1.8 I/O (Z → H)	x	106	35pF	0.9V	1.65V
Default LVC MOS 1.8 I/O (Z → L)	106	x	35pF	0.9V	1.65V
Default LVC MOS 1.8 I/O (H → Z)	x	106	5pF	$V_{OH} - 0.3$	1.65V
Default LVC MOS 1.8 I/O (L → Z)	106	x	5pF	$V_{OL} + 0.3$	1.65V

Note: Output test conditions for all other interfaces are determined by the respective standards.

ispXPGA Power Supply and NC Connections¹

Signal	256-Ball fpBGA ³	516-Ball fpBGA ³
V _{CC}	C3, C14, D4, D13, E5, E12, F6, F11, L6, L11, M5, M12, N4, N13, P3, P14	A9, A22, D4, D27, J1, J30, L11, L12, L15, L16, L19, L20, M11, M20, R11, R20, T11, T20, W11, W20, Y11, Y12, Y15, Y16, Y19, Y20, AB1, AB30, AG4, AG27, AK9, AK22
V _{CCO0}	F5, G5	F4, J4, M4, N11, P4, P11
V _{CCO1}	K5, L5	U4, U11, V11, W4, AB4, AE4
V _{CCO2}	M6, M7	Y13, Y14, AG6, AG9, AG12, AG14
V _{CCO3}	M10, M11	Y17, Y18, AG17, AG19, AG22, AG25
V _{CCO4}	K12, L12	U20, U27, V20, W27, AB27, AE27
V _{CCO5}	G12, F12	F27, J27, M27, N20, P20, P27
V _{CCO6}	E10, E11	D17, D19, D22, D25, L17, L18
V _{CCO7}	E6, E7	D6, D9, D12, D14, L13, L14
V _{CCP}	H3, J15	R4, T30
V _{CCJ}	A2	C4
GND	A1, A16, B2, B15, F7, F8, F9, F10, G6, G7, G8, G9, G10, G11, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, J11, K6, K7, K8, K9, K10, K11, L7, L8, L9, L10, R2, R15, T1, T16	A1, A30, B2, B29, C3, C28, M12, M13, M14, M15, M16, M17, M18, M19, N12, N13, N14, N15, N16, N17, N18, N19, P12, P13, P14, P15, P16, P17, P18, P19, R12, R13, R14, R15, R16, R17, R18, R19, T12, T13, T14, T15, T16, T17, T18, T19, U12, U13, U14, U15, U16, U17, U18, U19, V12, V13, V14, V15, V16, V17, V18, V19, W12, W13, W14, W15, W16, W17, W18, W19, AH3, AH28, AJ2, AJ29, AK1, AK30
GND _P	H15, J4	R29, T4
NC ²	—	LFX125: A10, A13, A16, A17, A24, A25, A26, A4, A5, A6, A7, AA1, AA2, AA28, AA29, AA3, AB28, AC1, AC28, AD1, AD27, AD4, AE28, AE29, AE3, AE30, AF27, AF28, AF29, AF3, AF4, AG1, AG10, AG11, AG15, AG2, AG20, AG23, AG24, AG29, AG3, AG8, AH1, AH15, AH19, AH2, AH20, AH23, AH24, AH30, AH7, AH8, AH9, AJ1, AJ12, AJ14, AJ15, AJ19, AJ20, AJ21, AJ23, AJ24, AJ25, AJ27, AJ30, AJ6, AJ7, AJ8, AK11, AK14, AK15, AK20, AK21, AK23, AK24, AK25, AK27, AK5, AK6, AK7, B10, B13, B16, B17, B18, B23, B24, B25, B5, B6, B7, C11, C13, C14, C16, C17, C22, C23, C24, C25, C6, C7, C8, D11, D16, D23, D24, D28, D29, D3, D7, D8, E30, E4, F1, F29, F30, G1, G2, G27, G28, G29, G30, H1, H2, H27, H28, H29, H30, J2, J28, J29, J3, K1, K2, K27, K28, K3, K4, L1, L2, L27, L3, L4, M1, M2, M29, M3, M30, V27, V28, V3, V4, W1, W30, Y1, Y27, Y28, Y3, Y30 LFX200: A26, A25, A24, A17, A10, A7, A6, A5, A4, B25, B24, B23, B17, B10, B7, B6, B5, C25, C24, C23, C22, C16, C11, C8, C7, C6, D24, D23, D16, D11, D8, D7, E30, F30, F29, F1, G30, G29, G28, G27, G2, G1, H30, H29, H28, H27, H2, H1, J29, J28, J3, J2, K28, K27, K4, K3, K2, K1, L27, L4, L3, L2, L1, M3, V28, V27, V4, V3, W30, W1, Y30, Y28, Y27, Y3, Y1, AA29, AA28, AA3, AA2, AA1, AD27, AD4, AE28, AE3, AF29, AF28, AF27, AF3, AG29, AG24, AG23, AG20, AG11, AG10, AG8, AG2, AG1, AH30, AH24, AH23, AH20, AH9, AH8, AH7, AH2, AH1, AJ30, AJ27, AJ25, AJ24, AJ23, AJ21, AJ15, AJ12, AJ8, AJ7, AJ6, AJ1, AK27, AK25, AK24, AK23, AK21, AK15, AK11, AK7, AK6, AK5

1. All grounds must be electrically connected at the board level.

2. NC pins should not be connected to any active signals, V_{CC} or GND.

3. Balls for GND, V_{CC} and V_{CCOx} are connected within the substrate to their respective common signals. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispXPGA Logic Signal Connections: 256-Ball fpBGA

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ²	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ²
C2	BK0_IO2	HSI0A_SOUTP	1P/HSI0	BK0_IO0	HSI0A_SOUTP	0P
-	GND (Bank 0)	-	-	-	-	-
D2	BK0_IO3	HSI0A_SOUTN	1N/HSI0	BK0_IO1	HSI0A_SOUTN	0N
B1	BK0_IO6	HSI0A_SINP	3P/HSI0	BK0_IO4	HSI0A_SINP	2P/HSI0
-	-	-	-	GND (Bank 0)	-	-
C1	BK0_IO7	HSI0A_SINN	3N/HSI0	BK0_IO5	HSI0A_SINN	2N/HSI0
D3	BK0_IO8	-	4P/HSI0	BK0_IO6	-	3P/HSI0
E3	BK0_IO9	VREF0	4N/HSI0	BK0_IO7	VREF0	3N/HSI0
D1	BK0_IO10	HSI0B_SOUTP	5P/HSI0	BK0_IO8	HSI0B_SOUTP	4P/HSI0
-	GND (Bank 0)	-	-	-	-	-
E1	BK0_IO11	HSI0B_SOUTN	5N/HSI0	BK0_IO9	HSI0B_SOUTN	4N/HSI0
E2	BK0_IO12	-	6P/HSI0	BK0_IO10	-	5P/HSI0
F2	BK0_IO13	-	6N/HSI0	BK0_IO11	-	5N/HSI0
F1	BK0_IO14	HSI0B_SINP	7P/HSI0	BK0_IO12	HSI0B_SINP	6P/HSI0
-	-	-	-	GND (Bank 0)	-	-
G1	BK0_IO15	HSI0B_SINN	7N/HSI0	BK0_IO13	HSI0B_SINN	6N/HSI0
F3	BK0_IO18	PLL_FBK0	9P	BK0_IO14	PLL_FBK0	7P/HSI0
-	GND (Bank 0)	-	-	-	-	-
G2	BK0_IO19	PLL_RST1	9N	BK0_IO15	PLL_RST1	7N/HSI0
E4	BK0_IO20	-	10P	BK0_IO16	-	8P/HSI0
F4	BK0_IO21	PLL_FBK1	10N	BK0_IO17	PLL_FBK1	8N/HSI0
H1	BK0_IO22	PLL_RST0	11P	BK0_IO18	PLL_RST0	9P
-	-	-	-	GND (Bank 0)	-	-
J1	BK0_IO23	-	11N	BK0_IO19	-	9N
H2	BK0_IO24	CLK_OUT0	12P	BK0_IO20	CLK_OUT0	10P
G3	BK0_IO25	CLK_OUT1	12N	BK0_IO21	CLK_OUT1	10N
-	GND (Bank 0)	-	-	-	-	-
G4	GCLK0	-	LVDS Pair0P	GCLK0	-	LVDS Pair0P
H4	GCLK1	-	LVDS Pair0N	GCLK1	-	LVDS Pair0N
H3	VCCP0	-	-	VCCP0	-	-
J4	GNDP0	-	-	GNDP0	-	-
J2	GCLK2	-	LVDS Pair1P	GCLK2	-	LVDS Pair1P
J3	GCLK3	-	LVDS Pair1N	GCLK3	-	LVDS Pair1N
-	GND (Bank 1)	-	-	-	-	-
H5	BK1_IO0	CLK_OUT2	13P	BK1_IO0	CLK_OUT2	11P
J5	BK1_IO1	CLK_OUT3	13N	BK1_IO1	CLK_OUT3	11N
K1	BK1_IO2	SS_CLKOUT0P	14P	BK1_IO2	SS_CLKOUT0P	12P
-	-	-	-	GND (Bank 1)	-	-
L1	BK1_IO3	SS_CLKOUT0N	14N	BK1_IO3	SS_CLKOUT0N	12N
K4	BK1_IO4	PLL_FBK2	15P	BK1_IO4	PLL_FBK2	13P
L4	BK1_IO5	PLL_FBK3	15N	BK1_IO5	PLL_FBK3	13N
K3	BK1_IO6	SS_CLKIN0P	16P	BK1_IO6	SS_CLKIN0P	14P

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved ¹
-	GND (Bank 2)	-	-
K36	BK2_IO19	-	71N
H38	BK2_IO20	-	72P
J38	BK2_IO21	-	72N
J39	BK2_IO22	-	73P
L36	BK2_IO23	-	73N
K38	BK2_IO24	-	74P
M36	BK2_IO25	-	74N
L37	BK2_IO26	-	75P
-	GND (Bank 2)	-	-
K39	BK2_IO27	-	75N
L38	BK2_IO28	-	76P
P35	BK2_IO29	-	76N
N36	BK2_IO30	-	77P
M37	BK2_IO31	-	77N
L39	BK2_IO32	-	78P
M38	BK2_IO33	-	78N
M39	BK2_IO34	-	79P
-	GND (Bank 2)	-	-
P36	BK2_IO35	-	79N
R36	BK2_IO36	-	80P
N37	BK2_IO37	-	80N
P38	BK2_IO38	-	81P
T35	BK2_IO39	-	81N
R37	BK2_IO40	-	82P
R38	BK2_IO41	-	82N
P39	BK2_IO42	-	83P
-	GND (Bank 2)	-	-
R39	BK2_IO43	-	83N
T38	BK2_IO44	-	84P
T36	BK2_IO45	-	84N
T37	BK2_IO46	-	85P
U36	BK2_IO47	-	85N
U37	BK2_IO48	-	86P
T39	BK2_IO49	-	86N
V36	BK2_IO50	-	87P
-	GND (Bank 2)	-	-
U38	BK2_IO51	-	87N
U39	BK2_IO52	-	88P
V38	BK2_IO53	-	88N
V37	BK2_IO54	-	89P
W36	BK2_IO55	-	89N
W35	BK2_IO56	-	90P

ispXPGA Logic Signal Connections: 900-Ball fpBGA

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
D3	BK0_IO0	-	0P	NC	-	-
E3	BK0_IO1	-	0N	NC	-	-
C2	BK0_IO2	-	1P	NC	-	-
-	GND (Bank 0)	-	-	-	-	-
C1	BK0_IO3	-	1N	NC	-	-
E4	BK0_IO4	-	2P	BK0_IO0	-	0P
F5	BK0_IO5	-	2N	BK0_IO1	-	0N
D2	BK0_IO6	HSI0A_SOUTP	3P	BK0_IO2	HSI0A_SOUTP	1P/HSI0
-	-	-	-	GND (Bank 0)	-	-
D1	BK0_IO7	HSI0A_SOUTN	3N	BK0_IO3	HSI0A_SOUTN	1N/HSI0
F4	BK0_IO8	-	4P	BK0_IO4	-	2P/HSI0
F3	BK0_IO9	-	4N	BK0_IO5	-	2N/HSI0
E2	BK0_IO10	HSI0A_SINP	5P/HSI0	BK0_IO6	HSI0A_SINP	3P/HSI0
-	GND (Bank 0)	-	-	-	-	-
E1	BK0_IO11	HSI0A_SINN	5N/HSI0	BK0_IO7	HSI0A_SINN	3N/HSI0
G6	BK0_IO12	VREF0	6P/HSI0	BK0_IO9	VREF0	4N/HSI0
G5	BK0_IO13	-	6N/HSI0	BK0_IO8	-	4P/HSI0
F1	BK0_IO14	HSI0B_SOUTP	7P/HSI0	NC	-	-
F2	BK0_IO15	HSI0B_SOUTN	7N/HSI0	NC	-	-
G4	BK0_IO16	-	8P/HSI0	NC	-	-
G3	BK0_IO17	-	8N/HSI0	NC	-	-
G2	BK0_IO18	HSI0B_SINP	9P/HSI0	NC	-	-
-	GND (Bank 0)	-	-	-	-	-
G1	BK0_IO19	HSI0B_SINN	9N/HSI0	NC	-	-
H3	BK0_IO20	-	10P/HSI0	NC	-	-
H4	BK0_IO21	-	10N/HSI0	NC	-	-
H1	BK0_IO22	HSI1A_SOUTP	11P/HSI0	NC	-	-
H2	BK0_IO23	HSI1A_SOUTN	11N/HSI0	NC	-	-
J7	BK0_IO24	-	12P/HSI0	NC	-	-
J6	BK0_IO25	-	12N/HSI0	NC	-	-
J1	BK0_IO26	HSI1A_SINP	13P/HSI1	NC	-	-
-	GND (Bank 0)	-	-	-	-	-
J2	BK0_IO27	HSI1A_SINN	13N/HSI1	NC	-	-
J4	BK0_IO28	-	14P/HSI1	NC	-	-
J5	BK0_IO29	-	14N/HSI1	NC	-	-
K1	BK0_IO30	HSI1B_SOUTP	15P/HSI1	BK0_IO10	HSI0B_SOUTP	5P/HSI0
-	-	-	-	GND (Bank 0)	-	-
K2	BK0_IO31	HSI1B_SOUTN	15N/HSI1	BK0_IO11	HSI0B_SOUTN	5N/HSI0
K5	BK0_IO32	-	16P/HSI1	BK0_IO12	-	6P/HSI0
K4	BK0_IO33	-	16N/HSI1	BK0_IO13	-	6N/HSI0
L1	BK0_IO34	HSI1B_SINP	17P/HSI1	BK0_IO14	HSI0B_SINP	7P/HSI0
-	GND (Bank 0)	-	-	-	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
AC27	BK4_IO21	-	134N/HSI5	NC	-	-
AD29	BK4_IO22	HSI6A_SINP	135P/HSI5	NC	-	-
AD30	BK4_IO23	HSI6A_SINN	135N/HSI5	NC	-	-
AB24	BK4_IO24	-	136P/HSI5	NC	-	-
AB25	BK4_IO25	-	136N/HSI5	NC	-	-
AC29	BK4_IO26	HSI6A_SOUTP	137P/HSI6	NC	-	-
-	GND (Bank 4)	-	-	-	-	-
AC30	BK4_IO27	HSI6A_SOUTN	137N/HSI6	NC	-	-
AB27	BK4_IO28	-	138P/HSI6	NC	-	-
AB26	BK4_IO29	-	138N/HSI6	NC	-	-
AB30	BK4_IO30	HSI6B_SINP	139P/HSI6	BK4_IO18	HSI3B_SINP	93P
-	-	-	-	GND (Bank 4)	-	-
AB29	BK4_IO31	HSI6B_SINN	139N/HSI6	BK4_IO19	HSI3B_SINN	93N
AA26	BK4_IO32	-	140P/HSI6	NC	-	-
AA27	BK4_IO33	-	140N/HSI6	NC	-	-
AA30	BK4_IO34	HSI6B_SOUTP	141P/HSI6	BK4_IO22	HSI3B_SOUTP	95P
-	GND (Bank 4)	-	-	-	-	-
AA29	BK4_IO35	HSI6B_SOUTN	141N/HSI6	BK4_IO23	HSI3B_SOUTN	95N
Y25	BK4_IO36	-	142P/HSI6	NC	-	-
Y26	BK4_IO37	-	142N/HSI6	NC	-	-
Y28	BK4_IO38	-	143P/HSI6	NC	-	-
Y27	BK4_IO39	-	143N/HSI6	NC	-	-
W25	BK4_IO40	-	144P/HSI6	NC	-	-
W26	BK4_IO41	-	144N/HSI6	NC	-	-
W27	BK4_IO42	-	145P	BK4_IO24	-	96P
-	GND (Bank 4)	-	-	-	-	-
W28	BK4_IO43	-	145N	BK4_IO25	-	96N
V24	BK4_IO44	-	146P	BK4_IO26	-	97P
-	-	-	-	GND (Bank 4)	-	-
V25	BK4_IO45	-	146N	BK4_IO27	-	97N
Y29	BK4_IO46	-	147P	BK4_IO32	-	100P
Y30	BK4_IO47	-	147N	BK4_IO33	-	100N
V27	BK4_IO48	PLL_RST4	148P	BK4_IO20	PLL_RST4	94P
V28	BK4_IO49	PLL_RST5	148N	BK4_IO21	PLL_RST5	94N
W29	BK4_IO50	-	149P	BK4_IO34	-	101P
-	GND (Bank 4)	-	-	GND (Bank 4)	-	-
W30	BK4_IO51	-	149N	BK4_IO35	-	101N
U25	BK4_IO52	-	150P	BK4_IO28	-	98P
U26	BK4_IO53	-	150N	BK4_IO29	-	98N
V29	BK4_IO54	SS_CLKIN1P	151P	BK4_IO30	SS_CLKIN1P	99P
V30	BK4_IO55	SS_CLKIN1N	151N	BK4_IO31	SS_CLKIN1N	99N
U28	BK4_IO56	PLL_FBK4	152P	BK4_IO36	PLL_FBK4	102P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
K30	BK5_IO22	HSI7B_SOUTP	166P/HSI8	BK5_IO22	HSI4B_SOUTP	116P/HSI4
-	-	-	-	GND (Bank 5)	-	-
K29	BK5_IO23	HSI7B_SOUTN	166N/HSI8	BK5_IO23	HSI4B_SOUTN	116N/HSI4
L28	BK5_IO24	-	167P/HSI8	BK5_IO24	-	117P/HSI5
L27	BK5_IO25	-	167N/HSI8	BK5_IO25	-	117N/HSI5
L26	BK5_IO26	HSI8A_SINP	168P/HSI8	BK5_IO26	HSI5A_SINP	118P/HSI5
-	GND (Bank 5)	-	-	-	-	-
L25	BK5_IO27	HSI8A_SINN	168N/HSI8	BK5_IO27	HSI5A_SINN	118N/HSI5
K27	BK5_IO28	-	169P/HSI8	BK5_IO28	-	119P/HSI5
K26	BK5_IO29	-	169N/HSI8	BK5_IO29	-	119N/HSI5
J30	BK5_IO30	HSI8A_SOUTP	170P/HSI8	BK5_IO30	HSI5A_SOUTP	120P/HSI5
-	-	-	-	GND (Bank 5)	-	-
J29	BK5_IO31	HSI8A_SOUTN	170N/HSI8	BK5_IO31	HSI5A_SOUTN	120N/HSI5
J26	BK5_IO32	-	171P/HSI8	NC	-	-
J27	BK5_IO33	-	171N/HSI8	NC	-	-
H30	BK5_IO34	HSI8B_SINP	172P/HSI8	NC	-	-
-	GND (Bank 5)	-	-	-	-	-
H29	BK5_IO35	HSI8B_SINN	172N/HSI8	NC	-	-
J25	BK5_IO36	-	173P/HSI9	NC	-	-
J24	BK5_IO37	-	173N/HSI9	NC	-	-
G30	BK5_IO38	HSI8B_SOUTP	174P/HSI9	NC	-	-
G29	BK5_IO39	HSI8B_SOUTN	174N/HSI9	NC	-	-
H27	BK5_IO40	-	175P/HSI9	NC	-	-
H28	BK5_IO41	-	175N/HSI9	NC	-	-
F30	BK5_IO42	HSI9A_SINP	176P/HSI9	NC	-	-
-	GND (Bank 5)	-	-	-	-	-
F29	BK5_IO43	HSI9A_SINN	176N/HSI9	NC	-	-
G27	BK5_IO44	-	177P/HSI9	NC	-	-
G28	BK5_IO45	-	177N/HSI9	NC	-	-
E30	BK5_IO46	HSI9A_SOUTP	178P/HSI9	NC	-	-
E29	BK5_IO47	HSI9A_SOUTN	178N/HSI9	NC	-	-
H26	BK5_IO48	-	179P/HSI9	BK5_IO33	-	121N/HSI5
H25	BK5_IO49	VREF5	179N/HSI9	BK5_IO32	VREF5	121P/HSI5
D30	BK5_IO50	HSI9B_SINP	180P/HSI9	BK5_IO34	HSI5B_SINP	122P/HSI5
-	GND (Bank 5)	-	-	-	-	-
D29	BK5_IO51	HSI9B_SINN	180N/HSI9	BK5_IO35	HSI5B_SINN	122N/HSI5
F28	BK5_IO52	-	181P	BK5_IO36	-	123P/HSI5
F27	BK5_IO53	-	181N	BK5_IO37	-	123N/HSI5
C30	BK5_IO54	HSI9B_SOUTP	182P	BK5_IO38	HSI5B_SOUTP	124P/HSI5
-	-	-	-	GND (Bank 5)	-	-
C29	BK5_IO55	HSI9B_SOUTN	182N	BK5_IO39	HSI5B_SOUTN	124N/HSI5
G26	BK5_IO56	-	183P	NC	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
D21	BK6_IO29	-	200N	NC	-	-
A21	BK6_IO30	-	201P	NC	-	-
B21	BK6_IO31	-	201N	NC	-	-
F20	BK6_IO32	DATA7	202P	BK6_IO18	DATA7	135P
-	-	-	-	GND (Bank 6)	-	-
E20	BK6_IO33	DATA6	202N	BK6_IO19	DATA6	135N
D20	BK6_IO34	-	203P	NC	-	-
-	GND (Bank 6)	-	-	-	-	-
C20	BK6_IO35	-	203N	NC	-	-
F19	BK6_IO36	DATA5	204P	BK6_IO22	DATA5	137P
E19	BK6_IO37	DATA4	204N	BK6_IO23	DATA4	137N
B20	BK6_IO38	-	205P	NC	-	-
A20	BK6_IO39	-	205N	NC	-	-
D19	BK6_IO40	-	206P	NC	-	-
C19	BK6_IO41	-	206N	NC	-	-
A19	BK6_IO42	-	207P	NC	-	-
-	GND (Bank 6)	-	-	-	-	-
B19	BK6_IO43	-	207N	NC	-	-
G18	BK6_IO44	-	208P	BK6_IO24	-	138P
F18	BK6_IO45	-	208N	BK6_IO25	-	138N
A18	BK6_IO46	-	209P	BK6_IO32	-	142P
B18	BK6_IO47	-	209N	BK6_IO33	-	142N
D18	BK6_IO48	-	210P	BK6_IO34	-	143P
-	-	-	-	GND (Bank 6)	-	-
C18	BK6_IO49	-	210N	BK6_IO35	-	143N
F17	BK6_IO50	DATA3	211P	BK6_IO26	DATA3	139P
-	GND (Bank 6)	-	-	GND (Bank 6)	-	-
E17	BK6_IO51	DATA2	211N	BK6_IO27	DATA2	139N
D17	BK6_IO52	-	212P	BK6_IO28	-	140P
C17	BK6_IO53	-	212N	BK6_IO29	-	140N
B17	BK6_IO54	DATA1	213P	BK6_IO30	DATA1	141P
A17	BK6_IO55	DATA0	213N	BK6_IO31	DATA0	141N
F16	BK6_IO56	-	214P	BK6_IO36	-	144P
E16	BK6_IO57	-	214N	BK6_IO37	-	144N
D16	BK6_IO58	-	215P	BK6_IO38	-	145P
-	GND (Bank 6)	-	-	-	-	-
C16	BK6_IO59	-	215N	BK6_IO39	-	145N
B16	BK6_IO60	-	216P	BK6_IO40	-	146P
A16	BK6_IO61	-	216N	BK6_IO41	-	146N
-	GND (Bank 6)	-	-	GND (Bank 6)	-	-
-	GND (Bank 7)	-	-	GND (Bank 7)	-	-
A15	BK7_IO0	-	217P	BK7_IO0	-	147P

“E-Series” Commercial

Part Number	Gates	Voltage	Speed Grade	Package	Balls
LFX125EB-05F256C	139K	2.5/3.3	-5	fpBGA	256
LFX125EB-04F256C	139K	2.5/3.3	-4	fpBGA	256
LFX125EB-03F256C	139K	2.5/3.3	-3	fpBGA	256
LFX125EC-04F256C	139K	1.8	-4	fpBGA	256
LFX125EC-03F256C	139K	1.8	-3	fpBGA	256
LFX125EB-05F516C	139K	2.5/3.3	-5	fpBGA	516
LFX125EB-04F516C	139K	2.5/3.3	-4	fpBGA	516
LFX125EB-03F516C	139K	2.5/3.3	-3	fpBGA	516
LFX125EC-04F516C	139K	1.8	-4	fpBGA	516
LFX125EC-03F516C	139K	1.8	-3	fpBGA	516
LFX125EB-05FH516C ¹	139K	2.5/3.3	-5	fpBGA	516
LFX125EB-04FH516C ¹	139K	2.5/3.3	-4	fpBGA	516
LFX125EB-03FH516C ¹	139K	2.5/3.3	-3	fpBGA	516
LFX125EC-04FH516C ¹	139K	1.8	-4	fpBGA	516
LFX125EC-03FH516C ¹	139K	1.8	-3	fpBGA	516
LFX200EB-05F256C	210K	2.5/3.3	-5	fpBGA	256
LFX200EB-04F256C	210K	2.5/3.3	-4	fpBGA	256
LFX200EB-03F256C	210K	2.5/3.3	-3	fpBGA	256
LFX200EC-04F256C	210K	1.8	-4	fpBGA	256
LFX200EC-03F256C	210K	1.8	-3	fpBGA	256
LFX200EB-05F516C	210K	2.5/3.3	-5	fpBGA	516
LFX200EB-04F516C	210K	2.5/3.3	-4	fpBGA	516
LFX200EB-03F516C	210K	2.5/3.3	-3	fpBGA	516
LFX200EC-04F516C	210K	1.8	-4	fpBGA	516
LFX200EC-03F516C	210K	1.8	-3	fpBGA	516
LFX200EB-05FH516C ¹	210K	2.5/3.3	-5	fpBGA	516
LFX200EB-04FH516C ¹	210K	2.5/3.3	-4	fpBGA	516
LFX200EB-03FH516C ¹	210K	2.5/3.3	-3	fpBGA	516
LFX200EC-04FH516C ¹	210K	1.8	-4	fpBGA	516
LFX200EC-03FH516C ¹	210K	1.8	-3	fpBGA	516
LFX500EB-05F516C	476K	2.5/3.3	-5	fpBGA	516
LFX500EB-04F516C	476K	2.5/3.3	-4	fpBGA	516
LFX500EB-03F516C	476K	2.5/3.3	-3	fpBGA	516
LFX500EC-04F516C	476K	1.8	-4	fpBGA	516
LFX500EC-03F516C	476K	1.8	-3	fpBGA	516
LFX500EB-05FH516C ¹	476K	2.5/3.3	-5	fpBGA	516
LFX500EB-04FH516C ¹	476K	2.5/3.3	-4	fpBGA	516
LFX500EB-03FH516C ¹	476K	2.5/3.3	-3	fpBGA	516
LFX500EC-04FH516C ¹	476K	1.8	-4	fpBGA	516
LFX500EC-03FH516C ¹	476K	1.8	-3	fpBGA	516
LFX500EB-05F900C	476K	2.5/3.3	-5	fpBGA	900
LFX500EB-04F900C	476K	2.5/3.3	-4	fpBGA	900
LFX500EB-03F900C	476K	2.5/3.3	-3	fpBGA	900
LFX500EC-04F900C	476K	1.8	-4	fpBGA	900